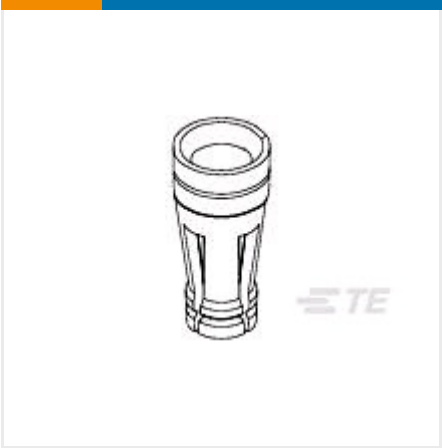




+ CONNECTORS
DISCRETE SOCKETS



✓ Active

TE CONNECTIVITY (TE)
8134-HC-5P3LF=PB FREE HOLTITE
[HOLTITE](#) | [HOLTITE](#)

9-1437514-0
TE Internal Number: 9-1437514-0
Alias ID: 8134-HC-5P3LF

[EU RoHS Compliant with Exemptions](#)
[EU ELV Compliant with Exemptions](#)
Hole Size (Recommended) 1.57 mm [.062 in]
Socket Length 3.51 mm [.138 in]
Sealant Without

Mating Pin Diameter Range .66 – .74 mm [.026 – .029 in]
Termination Method to PC Board Through Hole - Press-Fit

 **PRODUCT DRAWING**
English

 **3D PDF**

DOCUMENTATION

Product Drawings

HOLTITE CONTACTS
PDF
English

CAD Files

Customer View Model
3D_IGS.ZIP
English

Customer View Model
3D_STP.ZIP
English

Customer View Model

2D_DXF.ZIP

English

3D PDF

PDF

English

Product Specifications

Application Specification

AUGAT HOLTITE Sockets

PDF

English

Product Specification

AUGAT HOLTITE Sockets

PDF

English

FEATURES



Please review product documents or [contact us](#) for the latest agency approval information.

Please Note: Use the Product Drawing for all design activity.

Product Type Features

Connector & Contact Terminates To Printed Circuit Board

Product Type Contact

Profile Zero

Wire/Cable Type Discrete Wire

Body Features

Sealant Without

Sleeve Plating Material Tin

Sleeve Material Copper

Contact Features

Contact Current Rating (Max) (A) 5

Contact Type Socket

Contact Spring Plating Material Tin

Contact Transmits (Typical) Signal (Data)/Power

Contact Base Material Beryllium Copper

Contact Mating Area Plating Material Tin

Socket Type Discrete

Termination Features

Termination Method to PC Board Through Hole - Press-Fit

Termination Method to Wire/Cable Solder

Insertion Method Hand/Semi-Automatic/Automatic

Dimensions

- Socket Length** 3.51 mm [.138 in]
- Hole Size (Recommended)** 1.57 mm [.062 in]
- Mating Pin Diameter Range** .66 – .74 mm [.026 – .029 in]
- PCB Thickness (Recommended)** .79 – 3.18 mm [.03 – .05 in]

Usage Conditions

- Operating Temperature Range** -65 – 125 °C [-85 – 257 °F]

Packaging Features

- Packaging Method** Loose Piece
- Packaging Quantity** 2500

Other

- Spring Material** Beryllium Copper

PRODUCT COMPLIANCE



Statement of Compliance

- Statement of Compliance**
- PDF